

|    | Typ<br>e | L<br>#  | Hits   | Search Text   | DBs   |
|----|----------|---------|--------|---|---|
| 1  | BRS      | L1      | 141444 | "438"/\$.ccls.  | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 2  | BRS      | L2      | 576    | 1 and solid-state<br>near (imag\$3 or<br>device)                  | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 3  | BRS      | L3      | 1      | 2 and base near<br>flatness                                       | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 4  | BRS      | L4      | 71     | 2 and base  | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 5  | BRS      | L5      | 8      | 4 and flatness  | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 6  | BRS      | L7      | 0      | 5 and position\$3 near<br>hole?                                   | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 7  | BRS      | L8      | 1      | 2 and mold?   | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 8  | BRS      | L1<br>0 | 26     | (minamio-masanori or<br>horiki-hiroshi or<br>nishio-tetshuhi).in. | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 9  | BRS      | L1<br>1 | 0      | 10 and solid-state<br>near (imag\$3 or<br>device)                 | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 10 | BRS      | L1<br>2 | 0      | 10 and CCD  | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 11 | BRS      | L1<br>3 | 2072   | ((solid-state or<br>(solid near state))<br>near imaging).ti.      | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 12 | BRS      | L1<br>4 | 0      | 13 and base near<br>flatness                                      | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 13 | BRS      | L1<br>5 | 3      | 13 and mold?  | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 14 | BRS      | L1<br>6 | 4      | 13 and position\$3<br>near hole?                                  | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 15 | BRS      | L1<br>7 | 2      | 16 and mold\$3  | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 16 | BRS      | L1<br>8 | 6928   | ((solid-state or<br>(solid near state) or<br>CCD) near imaging)   | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 17 | BRS      | L2<br>0 | 260    | 18 and mold\$3  | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 18 | BRS      | L2<br>1 | 50     | 20 and tape   | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 19 | BRS      | L2<br>3 | 1      | 22 and curing   | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |

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| 20 | BRS  | L2<br>4 | 0    | 22 and position\$3<br>near hole? | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |
| 21 | BRS  | L2<br>2 | 5    | 21 and resin near<br>mold\$3     | USPAT; USOCR; EPO;<br>JPO; DERWENT; IBM_TDB |